TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74LVX04F,TC74LVX04FN,TC74LVX04FT

#### Hex Inverter

The TC74LVX04F/ FN/ FT is a high-speed CMOS hex inverter fabricated with silicon gate CMOS technology. Designed for use in 3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

This device is suitable for low-voltage and battery operated systems.

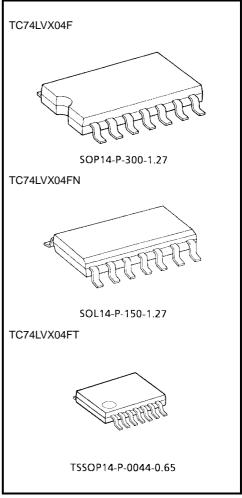
The internal circuit is composed of 3 stages including buffer output, which provide high noise immunity and stable output.

An input protection circuit ensures that 0 to 5.5V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

### **Features**

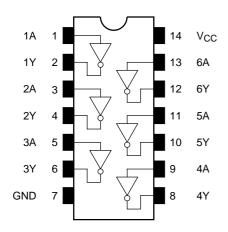
- High-speed:  $t_{pd} = 4.1 \text{ ns (typ.) (V}_{CC} = 3.3 \text{ V)}$
- Low power dissipation:  $I_{CC} = 2 \mu A \text{ (max) (Ta} = 25 ^{\circ}\text{C)}$
- Input voltage level:  $V_{IL} = 0.8 \text{ V (max)} (V_{CC} = 3 \text{ V})$   $V_{IH} = 2.0 \text{ V (min)} (V_{CC} = 3 \text{ V})$ 
  - Power-down protection provided on all inputs
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Low noise: VOLP = 0.5 V (max)
- Pin and function compatible with 74HC04

Note: xxxFN (JEDEC SOP) is not available in Japan.

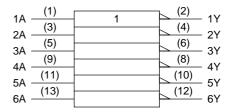


Weight SOP14-P-300-1.27: 0.18 g (typ.) SOL14-P-150-1.27: 0.12 g (typ.) TSSOP14-P-0044-0.65: 0.06 g (typ.)

### Pin Assignment (top view)



### **IEC Logic Symbol**



### **Truth Table**

Inputs	Outputs
Α	Υ
L	Н
Н	L

## **Maximum Ratings**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{CC} + 0.5$	V
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

## **Recommended Operating Conditions**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2.0 to 3.6	V
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100	ns/V



### **Electrical Characteristics**

### **DC Characteristics**

Characteristics Symbol 7		Test	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
						Min	Тур.	Max	Min	Max	
				2.0	1.5	_	_	1.5	_		
	H-level	V <sub>IH</sub>	_		3.0	2.0	_	_	2.0	_	
land to take a c					2.4	_	_	2.4	_	V	
Input voltage					2.0	_	_	0.5	_	0.5	v
	L-level	-level V <sub>IL</sub>	_		3.0	_	_	0.8	_	0.8	
					3.6	_	_	0.8	_	0.8	
			$V_{IN} = V_{IL}$	$I_{OH} = -50 \ \mu A$	2.0	1.9	2.0	_	1.9	_	
	H-level	V <sub>OH</sub>		$I_{OH} = -50 \ \mu A$	3.0	2.9	3.0	_	2.9		
Output voltage				$I_{OH} = -4 \text{ mA}$	3.0	2.58	_	_	2.48	_	V
Output voitage	Output voltage			$I_{OL} = 50 \mu A$	2.0	_	0.0	0.1	_	0.1	V
L-level	L-level	V <sub>OL</sub>	$V_{IN} = V_{IH} \\$	$I_{OL} = 50 \ \mu A$	3.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 4 \text{ mA}$	3.0	_	_	0.36	_	0.44		
Input leakage cur	rent	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		3.6		_	±0.1	_	±1.0	μΑ
Quiescent supply	current	Icc	$V_{IN} = V_{CC}$ or GND		3.6			2.0		20.0	μΑ

### AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit	
			V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max		
Propagation delay time	t <sub>pLH</sub>	-	2.7	15		5.4	10.1	1.0	12.5	- ns	
				50	_	7.9	13.6	1.0	16.0		
	t <sub>pHL</sub>		3.3 ± 0.3	15		4.1	6.2	1.0	7.5		
				50	_	6.6	9.7	1.0	11.0		
Output to output skew	t <sub>osLH</sub> (Note 1)	2.7	50	_	_	1.5		1.5	ns		
				(Note 1)		$3.3 \pm 0.3$	50	_	_	1.5	_
Input capacitance	C <sub>IN</sub>		•	(Note 2)	_	4	10	_	10	pF	
Power dissipation capacitance	C <sub>PD</sub>			(Note 3)	_	18	_	_	_	pF	

Note 1: Parameter guaranteed by design.  $(t_{OSLH} = |t_{DLHm} - t_{DLHn}|, \, t_{OSHL} = |t_{DHLm} - t_{DHLn}|)$ 

Note 2: Parameter guaranteed by design.

Note 3: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

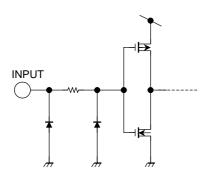
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/6 \text{ (per gate)}$ 

# Noise Characteristics (Ta = 25°C, input: $t_r = t_f = 3$ ns, $C_L = 50$ pF)

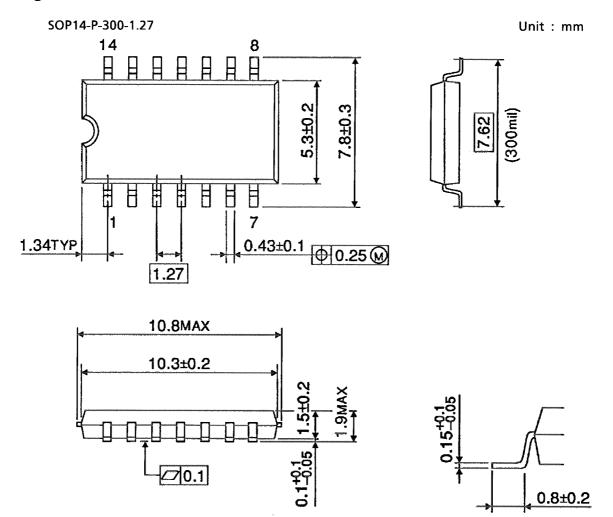
Characteristics		Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Limit	Unit
Quiet output maximum dynamic	V <sub>OL</sub>	V <sub>OLP</sub>	_	3.3	0.3	0.5	٧
Quiet output minimum dynamic	V <sub>OL</sub>	V <sub>OLV</sub>	_	3.3	-0.3	-0.5	٧
Minimum high level dynamic input voltage	V <sub>IH</sub>	$V_{IHD}$	<u> </u>	3.3	_	2.0	٧
Maximum low level dynamic input voltage	V <sub>IL</sub>	$V_{ILD}$	_	3.3		0.8	<b>V</b>

## **Input Equivalent Circuit**



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## **Package Dimensions**



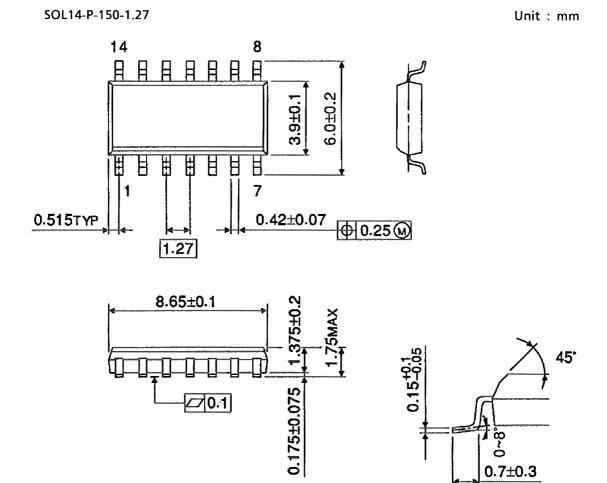
5

Weight: 0.18 g (typ.)

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# **TOSHIBA**

### **Package Dimensions**



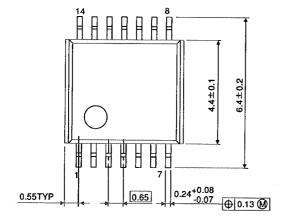
6

Weight: 0.12 g (typ.)

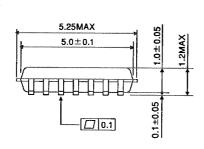
Unit: mm

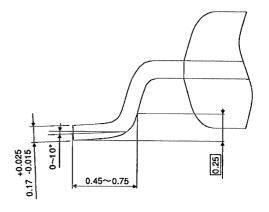
### **Package Dimensions**

TSSOP14-P-0044-0.65









Weight: 0.06 g (typ.)

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